



thin (metal) film flat chip resistors

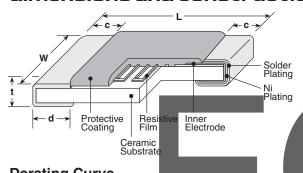


features



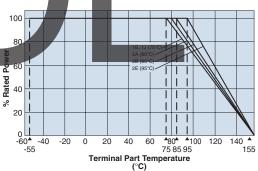
- Nickel chromium thin film resistor element
- Products with lead-free terminations meet EU RoHS requirements

dimensions and construction



For resistors operated at an ambient temperature of 70°C or above, a power rating shall be derated in accordance with the above derating curve.

Type **Dimensions** inches (mm) (Inch Size Code) С .039 +.004 .01 +.002 **RN73 1E** .02±.002 .008±.004 .014±.002 (0402) $(1.0^{+0.1}_{-0.05})$ (0.5 ± 0.05) (0.2 ± 0.1) $(0.25^{+0.05}_{-0.1})$ (0.35 ± 0.05) **RN731J** .063±.008 .031±.004 .012±.004 .012±.004 .018±.004 (0603) (1.6 ± 0.2) (0.8 ± 0.1) (0.3 ± 0.1) (0.3 ± 0.1) (0.45 ± 0.1) .012 ^{+.008} _{-.004} .079±.008 (2.0±0.2) .049±.008 .016±.008 .02±.004 RN73 2A (1.25 ± 0.2) $(0.3^{+0.2}_{-0.1})$ (0.4 ± 0.2) (0.5 ± 0.1) RN73 2 (1206) .063±.008 .016 +.008 (1.6 ± 0.2) .02±.012 .024±.004 .008 126 (3.2: RN73 2 .098±.008 (0.5 ± 0.3) $(0.4^{+0.2}_{-0.1})$ (0.6 ± 0.1) (1210) (2.5 ± 0.2)



For resistors operated terminal part temperature of described for each size or above, a power rating shall be derated in accordance with derating curve. Please refer to "Introduction of the derating curves based on the terminal part temperature" in the beginning of our catalog before use.

ordering information

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RN73	2B	Т				
Туре	Size	Termination Material				
	1E	T: Sn				
	1J	L: SnPb				
	2A					
	2B					
	2E					

IE.					
Packaging					
TP: 0402: 7" 2mm pitch punch paper					
TD: 0603, 0805, 1206, 1210: 7" 4mm pitch punched paper					
TDD: 0603, 0805, 1206, 1210: 10" paper tape					
TE: 0805, 1206, 1210: 7" embossed plastic					
TED: 0805, 1206, 1210: 10" embossed plastic					
For further information on packaging, please refer to Appendix A					

1002	В	25		
Nominal Resistance	Tolerance	T.C.R. (ppm/°C)		
3 significant	A: ±0.05%	05		
figures + 1	B: ±0.1%	10		
multiplier	C: ±0.25%	25		
"R" indicates decimal on	D: ±0.5%	50		
value <100Ω	F: ±1.0%	100		

Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.

4/17/20





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applications and ratings

Part Designation	Power Rating¹ Rated @ 70°C Ambient			(ppm/°C)	Resistance Range (Ω) E-24, E-96, E-192*				Absolute Max. Working	Absolute Max. Overload		
Designation	General	Power	Temp.	Temp.	Max.	(A±0.05%)	(B±0.1%)	(C±0.25%)	(D±0.5%)	(F±1.0%)	Voltage	Voltage
RN731E	063///	93W —	70°C	75°C	±25	_	100 - 100k	100 - 100k	10 - 120k	10 - 120k	- 50V	100V
THATOTE	.06344				±50	_	100 - 100k	100 - 100k	10 - 120k	10 - 120k		
			70°C	75°C	±5	1K - 47k	100 - 47k	_	_		75V	150V
		.1W			±10	1K - 47k	100 - 47k	100 - 47k	100 - 47k	100 - 47k		
RN731J	.063W				±25	1K - 47k	15 - 360k	15 - 360k	10 - 360k	10 - 360k		
					±50		15 - 360k	15 - 360k	10 - 360k	10Ω - 360k		
					±100	_	_	_	10 - 360k	10 - 360k		
		.125W	70°C	80°C	±5	100 - 100k	100 - 100k	_	_		150V	300V
	.1W				±10	100 - 100k	100 - 100k	100 - 100k	100 - 100k	100 - 100k		
RN732A					±25	51 - 100k	15 - 1M	15 - 1M	10 - 1M	10 - 1M		
					±50		15 - 1M	15 - 1M	10 - 1M	10 - 1M		
					±100			_	10 - 1M	10 - 1M		
		V .25W	70°C	85°C	±5	100 - 300k	100 - 300k	_			200V	400V
					±10	100 - 300k	100 - 300k	100 - 300k	100 - 300k	100 - 300k		
RN732B	.125W				±25	51 - 300k	15 - 1M	15 - 1M	10 - 1M	10 - 1M		
					±50		15 - 1M	15 - 1M	10 - 1M	10 - 1M		
					±100		_	_	10 - 1M	10 - 1M		
	.25W	/	70°C	95°C	±10	100 - 510k	100 - 510k	100 - 510k	100 - 510k	100 - 510k	200V	400V
RN732E					±25	51 - 510k	15 - 1M	15 - 1M	10 - 1M	10 - 1M		
	.20**				±50		15 - 1M	15 - 1M	10 - 1M	10 - 1M		
					±100	_	-		10 - 1M	10 - 1M		

^{*} No marking on E-192 values

Operating Temperature Range: -55°C to +155°C

1 Reliability performance is different. Please confirm the performance table. If any questions should arise whether to use the "Rated Ambient Temperature" or the "Rated Terminal Part Temperature", please give priority to the "Rated Terminal Part Temperature". Prior to use and for more details refer to "Introduction of the derating curves on the terminal part temperature" in the beginning of the catalog.

environmental applications

Performance Characteristics

	Requirement A	R ±(%+0.05Ω)				
Parameter	Parameter Limit Typical		Test Method			
Resistance	Within specified tolerance	_	25°C			
T.C.R.	Within specified T.C.R.	_	+25°C/+125°C: T.C.R. = ±5 (X10°/K) +25°C/-55°C and +25°C/+125°C: all others			
Overload (Short time)	General: ±0.1%	±0.01%	Rated Voltage x 2.5 or Max. overload voltage, whichever is less for 5 secon			
	High Power: ±0.5%	±0.03%	Trated voltage x 2.0 of wax. overload voltage, whichever is 1035 for 5 3000			
Resistance to Solder Heat	±0.1%	±0.04%	260°C ± 5°C, 10 seconds ± 1 second			
Rapid Change of Temperature	±0.25%	±0.03%	-55°C (30 minutes), +125°C (30 minutes), 300 cycles			
Moisture Resistance	General: ±0.5%	±0.06%	40°C + 0°C 00°/ 00°/ DLL 1000 bours 1 5 br ON 0 5 br OFF guelo			
	High Power: ±0.5%	±0.07%	40°C ± 2°C, 90%-95% RH, 1000 hours, 1.5 hr ON, 0.5 hr OFF cycle			
Endurance at 70°C	General: ±0.25%	±0.02%	70°C ± 2°C, 1000 hours, 1.5 hr ON, 0.5 hr OFF cycle			
	High Power: ±0.5%	±0.1%	70 0 ± 2 0, 1000 110013, 1.3 111 ON, 0.3 111 OFF Cycle			
High Temperature Exposure	±0.25%	±0.1%	+125°C, 1000 hours			
Tilgit temperature Exposure	±0.5%	±0.25%	+155°C, 1000 hours			

Precautions for Use

- The properly and electrostatically measured taping materials are used for the components, but attention should be paid to the fact that there is some danger the parts absorb on the top tapes to cause a failure
 in the mounting and the parts are destructed by static electricity (1kV and more: 1J, 2A, 2B, 2E 0.5kV and more: 1E, Human Body Model 100pF 1.5kΩ) to change the resistance in the conditions of an excessive
 dryness or after the parts are given vibration for a long time as they are packaged on the tapes. Similarly, care should be given not to apply the excessive static electricity when mounting on the boards.
- Ionic impurities such as flux etc. that are attached to these products or those mounted onto a PCB, negatively affect their moisture resistance, corrosion resistance, etc. The flux may contain ionic substances like chlorine, acid, etc. while perspiration and saliva include ionic impurities like sodium (Na), chlorine (CI-) etc. Therefore these kinds of ionic substances may induce electrical corrosion when they invade into the products. Either thorough washing or using RMA solder and flux are necessary since lead free solder contains ionic substances. Washing process is needed, before putting on moisture proof material in order to prevent electrical corrosion.
- The upper electrodes could be peeled off when a heat-resistant masking tape is attached to the mounted chip resistors and then detached from them. It is confirmed that the adhesiveness gets stronger due to the exposure to heat under mounting. Accordingly, we recommend the use of masking tape be refrained. If the use of heat-resistant masking tape is unavoidable, please make sure that the adhesives on the tape do not directly come in contact with the product.
- When high-pressure shower cleaning is implemented, there is a possibility of exfoliation of the top electrodes caused by the water pressure stress so please avoid the implementation.
- If the implementation is unavoidable, then please evaluate the products beforehand.

For Surface Temperature Rise Graph see Environmental Applications. Additional environmental applications can also be found at www.koaspeer.com Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use. 9/30/19

